

Optimize Power Distribution in Low Voltage Applications with Integrated Load Switches



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High-speed, low-power memory banks and processors are becoming more common with innovation in Smartphones, 5G, IoT, automotive infotainment, and ADAS. As the trend towards low-voltage rails continues, finding a switching solution that can operate from input voltages below 1.8 V is imperative. When a system calls for specific power distribution, power sequencing, or power savings, a load switch can be used to meet these specific timing or power savings requirements.

A load switch is a device that passes power from the supply to the load. The key benefits of using an integrated load switch when input voltage is less than 1.5 V are that the load switch maintains low on-resistance, reduces BOM count, and provides additional integrated features, as shown in [Table 1-1](#). This document presents three switching solutions and explains how an integrated load switch optimizes low-input voltage applications.

Table 1-1. Low-Input Voltage Switching Solutions

	V _{IN} < 1.5 V	Low R _{DS(on)}	Integrated Features	BOM Count
TI Integrated Load Switch	✓	✓	✓	1
Discrete PMOS	✗	✗	✗	6+
Discrete NMOS	✓	✓	✗	3+

Discrete MOSFET Solutions

The simplest and most common discrete power-switching solutions use a PMOS transistor to pass power from input to output. As shown in [Figure 1](#), the enable signal drives the pass FET gate while the input voltage is tied to the pass FET source. To turn on the FET, the enable signal must be pulled low. When the active low-enable signal is activated, the FET turns on and the load connects to the input voltage supply.

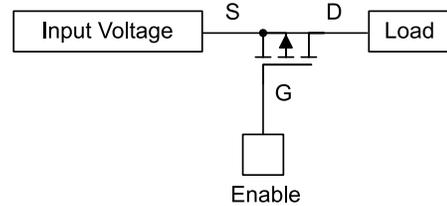


Figure 1. Discrete PMOS Switch

One of the drawbacks of using a PMOS transistor, is the transistor does not perform well in low input voltage applications. For the PMOS to turn on, the gate-to-source voltage must be less than the threshold voltage ($V_{GS} < V_{TH}$). When V_{GS} is close in value to V_{TH} , the FET partially turns on. With the pass FET not fully on, the device on-resistance ($R_{DS(on)}$) is very high. The resulting large voltage drop and high-power dissipation across the FET leads to reduced efficiency and thermal management concerns.

For example, consider the TI PMOS device, [CSD23202W10](#), that has a threshold voltage of $V_{TH} = -0.6$ V. By applying 0.65 V at the input of the [CSD23202W10](#), the application limits the maximum V_{GS} to -0.65 V, and the FET only turns on partially. [Figure 2](#) shows the corresponding exponential increase in $R_{DS(on)}$ when the input voltage is less than 1.5 V.

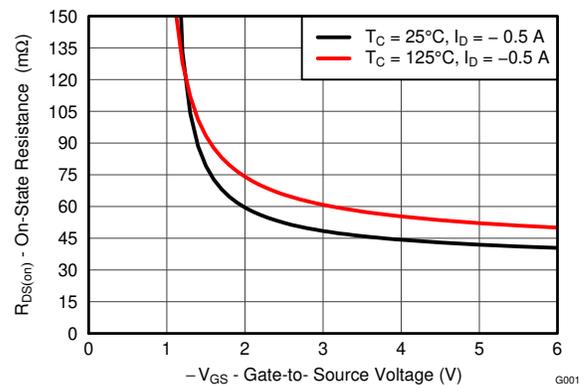


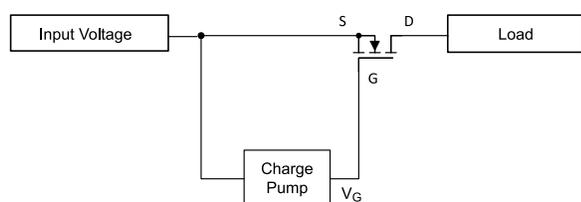
Figure 2. On-Resistance vs. V_{GS} for CSD23202W10

While the [CSD23202W10](#) is a switching solution with good performance metrics when input voltage is greater than 1.5 V, it is not ideal for low-input voltage applications. Even with various configurations of additional resistors, capacitors, and NMOS transistors, the discrete PMOS solution continues to have diminished performance at lower input voltages.

The second type of switching solution uses an NMOS transistor as the main power switch. To turn on an NMOS, the gate-to-source voltage must be higher than the threshold voltage ($V_{GS} > V_{TH}$). To meet this condition, the gate voltage is raised above the input voltage through a higher voltage rail within the system or a charge pump, as shown in [Figure 3](#). The active high-gate voltage ensures that even low-input voltage can pass through the switch while also maintaining a low on-resistance.

Figure 3. Discrete NMOS Switch

$$V_G = N \cdot \text{Input Voltage}$$



However, the additional required components lead to a larger PCB footprint, increased BOM count, and higher cost. While this tech note only covers two discrete solutions, the application report [Integrated Load Switches Versus Discrete MOSFETs](#) compares the performance of numerous discrete switching solutions with the integrated load switch.

Achieve Optimal Low Voltage Performance Using Integrated Load Switches

When compared with discrete switching solutions, integrated load switches maintain a constant $R_{DS(on)}$ across a spectrum of input voltages without added circuit complexity, which contributes to reduced solution size and cost savings. On-resistance is maintained across the entire input voltage range due to the inclusion of a bias voltage, VBIAS, which is higher than the input voltage to provide power to run the internal functions of the device.

For example, [Table 1-2](#) shows different load switch options that support input voltages as low as 0.6 V while maintaining a steady $R_{DS(on)}$ at room temperature.

Table 1-2. Integrated Load Switch Features

Device	Input Voltage Range (V)		$R_{DS(on)}$ (m Ω)	Channel Count	VBIAS
	MIN	MAX			
TPS22990	0.6	5.5	3.9	Single	✓
TPS22975		5.7	16	Single	✓
TPS22976			14	Dual	✓

Sustaining low on-resistance reduces the voltage drop across the device, ensuring that all the input voltage is transmitted to the load. Therefore, load switches maintain high efficiency and performance regardless of low VIN. [Figure 4](#) illustrates the constant on-resistance the [TPS22990](#) maintains across the entire input voltage range at different temperatures. In contrast, PMOS solutions such as the [CSD23202W10](#) experience an exponential increase in $R_{DS(on)}$ when used as a load switch at lower input voltages.

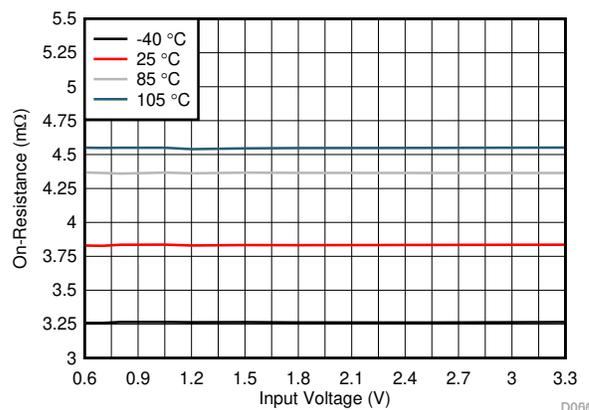


Figure 4. On-Resistance vs. VIN for TPS22990

Integrated load switches also provide additional features not available with discrete switching solutions such as quick output discharge, configurable rise time, and thermal shutdown. Common design challenges and how to solve them with integrated power switches are further addressed in [11 Ways to Protect Your Power Path](#).

Conclusion

As industry develops more processors and memory banks with lower core voltage and I/O rails, low input voltage switching solutions contribute to power management across various end equipments. Integrated load switches optimize power performance by maintaining low on-resistance and incorporating additional features that fine-tune efficiency. Integrated load switch options that enhance power distribution and savings in low-input voltage applications can be found on the TI.com portal at [Load Switches](#).

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